Agilent HCPL-250L/050L/253L/053L LVTTL/LVCMOS Compatible 3.3 V Optocouplers (1 Mb/s)

Data Sheet

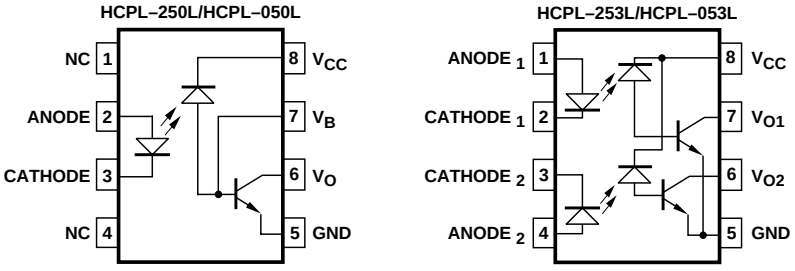
Description

These diode-transistor optocouplers use an insulating layer between a LED and an integrated photodetector to provide electrical insulation between input and output. Separate connections for the photodiode bias and output-transistor collector increase the speed up to a hundred times that of a conventional phototransistor coupler by reducing the base-collector capacitance.

These optocouplers are available in an 8-pin DIP and in an industry standard SO-8 package. The following is a cross reference table listing the 8-pin DIP part number and the electrically equivalent SO-8 part number.

The SO-8 does not require "through holes" in a PCB. This package occupies approximately one-third the footprint area of the

Functional Diagram



TRUTH TABLE (POSITIVE LOGIC)

LED	V_O
ON	LOW
OFF	HIGH

Features

- Low power consumption
- High speed: 1 Mb/s
- LVTTL/LVCMOS compatible
- Available in 8-pin DIP, SO-8
- Open collector output
- Guaranteed performance from temperature: 0°C to +70°C
- Safety approval, UL, CSA, IEC/EN/DIN EN 60747-5-2

Applications

- High voltage insulation
- Video signal isolation
- Power translator isolation in motor drives
- Line receivers
- Feedback element in switched mode power supplies
- High speed logic ground isolation – LVTTL/LVCMOS
- Replaces pulse transformers
- Replaces slow phototransistor isolators
- Analog signal ground isolation

A 0.1 µF bypass capacitor must be connected between pins 5 and 8.

CAUTION: It is advised that normal static precautions be taken in handling and assembly of this component to prevent damage and/or degradation which may be induced by ESD.

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standard dual-in-line package. The lead profile is designed to be compatible with standard surface mount processes.

These optocouplers can be used in LVTTL/LVCMOS or wide bandwidth analog applications.

The common mode transient immunity of 1000 V/µs minimum to typical at V_{CM} = 10 V guaranteed for these optocouplers.

8-Pin DIP	SO-8 Package
HCPL-250L	HCPL-050L
HCPL-253L	HCPL-053L

Ordering Information

Specify Part Number followed by Option Number (if desired).

Example:

HCPL-250L#XXXX

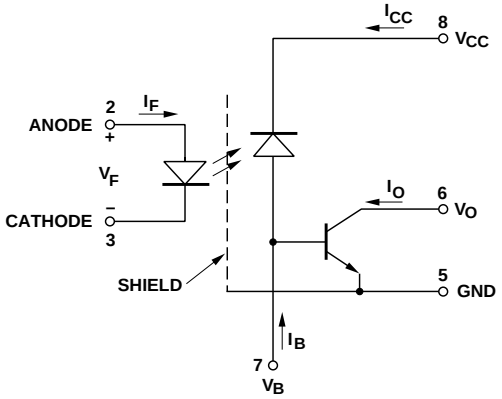
- 060 = IEC/EN/DIN EN 60747-5-2 V_{IORM}
- 500 = Tape and Reel Packaging Option
- XXXE = Lead Free Option

Option data sheets available. Contact Agilent sales representative or authorized distributor for information.

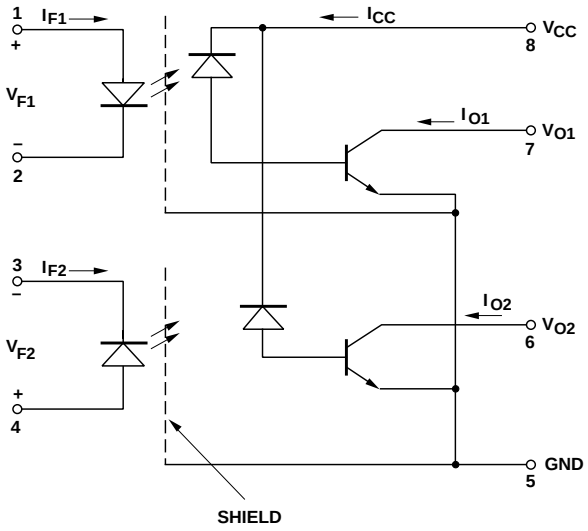
Remarks: The notation "#" is used for existing products, while (new) products launched since 15th July 2001 and lead free option will use "-"

Schematic

HCPL-250L/HCPL-050L

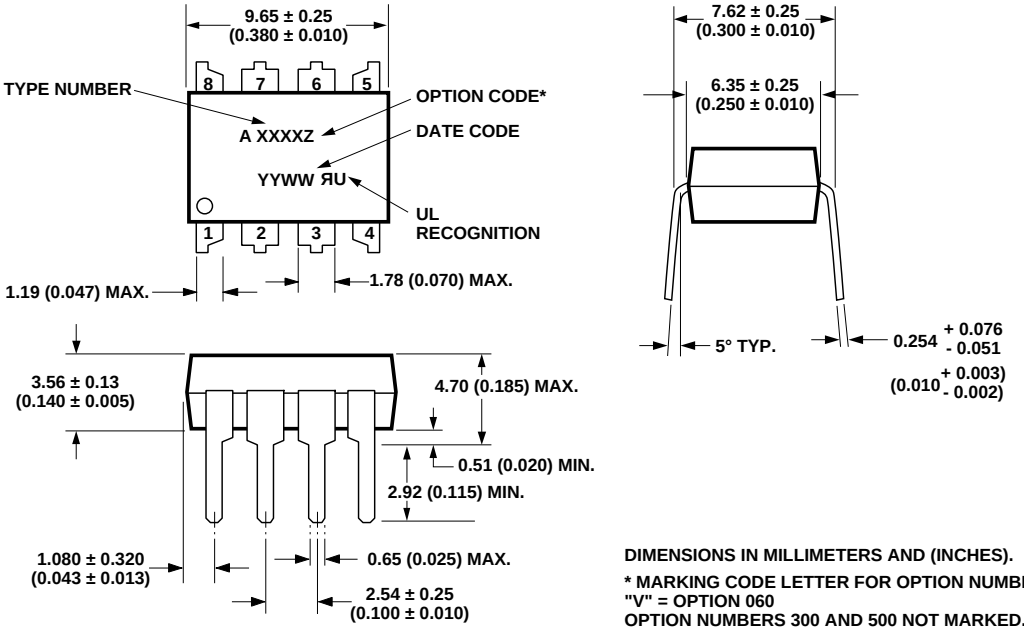


HCPL-253L/HCPL-053L



Package Outline Drawings

8-Pin DIP Package

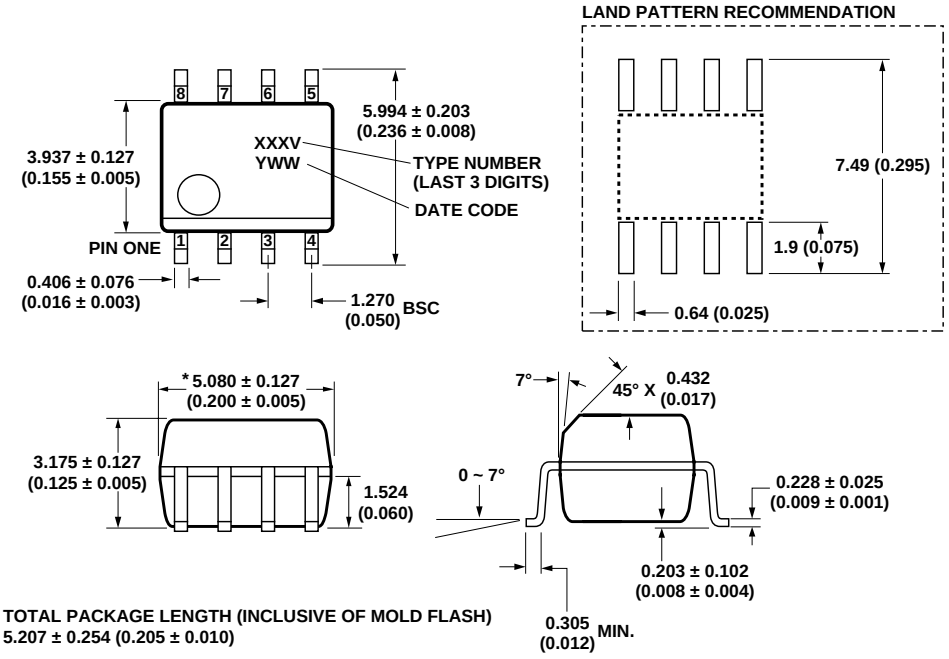


DIMENSIONS IN MILLIMETERS AND (INCHES).

* MARKING CODE LETTER FOR OPTION NUMBERS
"V" = OPTION 060
OPTION NUMBERS 300 AND 500 NOT MARKED.

NOTE: FLOATING LEAD PROTRUSION IS 0.25 mm (10 mils) MAX.

Small Outline SO-8 Package



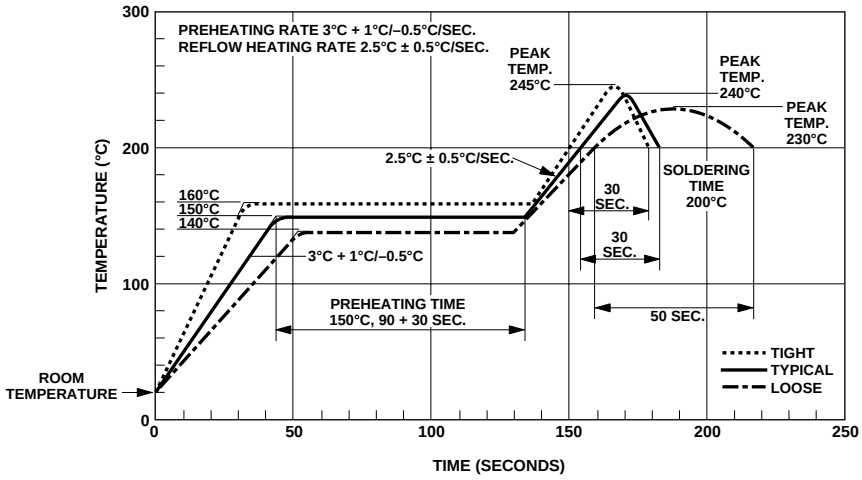
* TOTAL PACKAGE LENGTH (INCLUSIVE OF MOLD FLASH)
5.207 ± 0.254 (0.205 ± 0.010)

DIMENSIONS IN MILLIMETERS (INCHES).
LEAD COPLANARITY = 0.10 mm (0.004 INCHES) MAX.

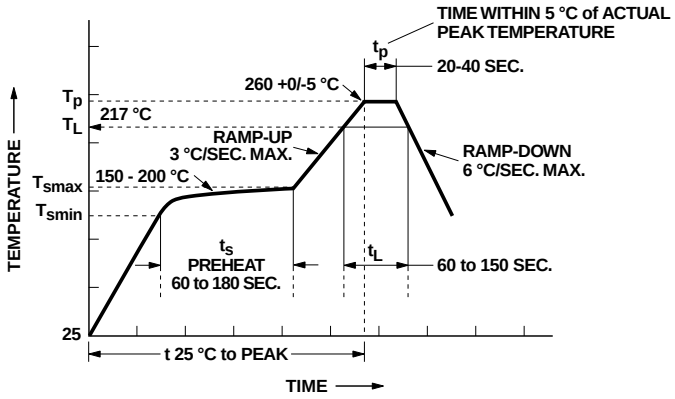
OPTION NUMBER 500 NOT MARKED.

NOTE: FLOATING LEAD PROTRUSION IS 0.15 mm (6 mils) MAX.

Solder Reflow Temperature Profile



Recommended Pb-Free IR Profile



NOTES:
THE TIME FROM 25 °C to PEAK TEMPERATURE = 8 MINUTES MAX.
T_{smax} = 200 °C, T_{smin} = 150 °C

Regulatory Information

The devices contained in this data sheet have been approved by the following organizations:

UL

Approval under UL 1577, Component Recognition Program, File E55361.

CSA

Approval under CSA Component Acceptance Notice #5, File CA 88324.

IEC/EN/DIN EN 60747-5-2

Approved under:
IEC 60747-5-2:1997 + A1:2002
EN 60747-5-2:2001 + A1:2002
DIN EN 60747-5-2 (VDE 0884 Teil 2):2003-01

Insulation and Safety Related Specifications

Parameter	Symbol	8-Pin DIP (300 Mil) Value	SO-8 Value	Units	Conditions
Minimum External Air Gap (External Clearance)	L(101)	7.1	4.9	mm	Measured from input terminals to output terminals, shortest distance through air.
Minimum External Tracking (External Creepage)	L(102)	7.4	4.8	mm	Measured from input terminals to output terminals, shortest distance path along body.
Minimum Internal Plastic Gap (Internal Clearance)		0.08	0.08	mm	Through insulation distance, conductor to conductor, usually the direct distance between the photoemitter and photodetector inside the optocoupler cavity.
Tracking Resistance (Comparative Tracking Index)	CTI	200	200	Volts	DIN IEC 112/VDE 0303 Part 1
Isolation Group		IIIa	IIIa		Material Group (DIN VDE 0110, 1/89, Table 1)

IEC/EN/DIN EN 60747-5-2 Insulation Related Characteristics

Description	Symbol	PDIP Option 060	SO-8 Option 60	Units
Installation classification per DIN VDE 0110/1.89, Table 1				
for rated mains voltage ≤ 150 V rms			I-IV	
for rated mains voltage ≤ 300 V rms		I-IV	I-III	
for rated mains voltage ≤ 600 V rms		I-III	I-II	
Climatic Classification		55/85/21	55/85/21	
Pollution Degree (DIN VDE 0110/1.89)		2	2	
Maximum Working Insulation Voltage	V_{IORM}	630	566	V_{peak}
Input to Output Test Voltage, Method b* V_{IORM} x 1.875 = V_{PR}, 100% Production Test with t_m = 1 sec, Partial Discharge < 5 pC	V_{PR}	1181	1063	V_{peak}
Input to Output Test Voltage, Method a* V_{IORM} x 1.5 = V_{PR}, Type and Sample Test, t_m = 60 sec, Partial Discharge < 5 pC	V_{PR}	945	849	V_{peak}
Highest Allowable Overvoltage* (Transient Overvoltage, t_{ini} = 10 sec)	V_{IOTM}	6000	4000	V_{peak}
Safety Limiting Values (Maximum values allowed in the event of a failure, also see Figure 16, Thermal Derating curve.)				
Case Temperature	T_S	175	150	°C
Input Current	$I_{S,INPUT}$	230	150	mA
Output Power	$P_{S,OUTPUT}$	600	600	mW
Insulation Resistance at T_S, V_{IO} = 500 V	R_S	$\geq 10^9$	$\geq 10^9$	Ω

*Refer to the front of the optocoupler section of the current catalog, under Product Safety Regulations section, IEC/EN/DIN EN 60747-5-2, for a detailed description.

Note: Isolation characteristics are guaranteed only within the safety maximum ratings which must be ensured by protective circuits in application.

Absolute Maximum Ratings

Parameter	Symbol	Min.	Max.	Units	Note
Storage Temperature	T_S	–55	125	°C	
Operating Temperature	T_A	–55	100	°C	
		–55	85		
Average Forward Input Current	$I_{F(AVG)}$		25	mA	1
Peak Forward Input Current (50% duty cycle, 1 ms pulse width)	$I_{F(PEAK)}$		50	mA	2
(50% duty cycle, 1 ms pulse width)			40		
Peak Transient Input Current (≤ 1 μs pulse width, 300 pps)	$I_{F(TRANS)}$		1	A	
			0.1		
Reverse LED Input Voltage (Pin 3-2)	V_R		5	V	
Input Power Dissipation	P_{IN}		45	mW	3
			4		
Average Output Current (Pin 6)	$I_{O(AVG)}$		8	mA	
Peak Output Current	$I_{O(PEAK)}$		16	mA	
Emitter-Base Reverse Voltage	V_{EBR}		5	V	
Supply Voltage (Pin 8-5)	V_{CC}	–0.5	7	V	
Output Voltage (Pin 6-5)	V_O	–0.5	7	V	
Base Current	I_B		5	mA	
Output Power Dissipation	P_O		100	mW	4
Lead Solder Temperature (Through Hole Parts Only)					
1.6 mm below seating plane, 10 sec.	T_{LS}		260	°C	
up to seating plane, 10 seconds			260	°C	
Reflow Temperature Profile	T_{RP}	See Package Outline Drawings section			

Recommended Operating Conditions

Parameter	Symbol	Min.	Max.	Units
Power Supply Voltage	V_{CC}	2.7	3.6	V
Forward Input Current	$I_{F(ON)}$	16	20	mA
Forward Input Voltage	$V_{F(OFF)}$	0	0.8	V
Operating Temperature	T_A	0	85	°C

Electrical Specifications (DC)

Over Recommended Temperature (T_A = 0°C to +70°C), V_{CC} = 3.3 V, I_F = 16 mA, unless otherwise specified. See Note 13.

Parameter	Sym.	Device	Min.	Typ.	Max.	Units	Test Conditions			Fig.	Note
Current Transfer Ratio	CTR		15	20	50	%	T_A = 25°C	V_O = 0.4 V	I_F = 16 mA, V_{CC} = 3.3 V	2	5, 11
Logic Low Output Voltage	V_{OL}			0.05	0.3	V	T_A = 25°C	I_O = 3.0 mA	I_F = 16 mA, V_{CC} = 3.3 V		
Logic High Output Current	I_{OH}			0.003	1	µA	T_A = 25°C	V_O = V_{CC} = 3.3 V	I_F = 0 mA	3	
Logic Low Supply Current	I_{CCL}	 Dual		43.0	100 300	µA	I_F = 16 mA, V_O = Open, V_{CC} = 3.3 V				13
Logic High Supply Current	I_{CCH}	 Dual		0.005	0.3 10	µA	T_A = 25°C	I_F = 0 mA, V_O = Open, V_{CC} = 3.3 V			13
Input Forward Voltage	V_F			1.52	1.7	V	T_A = 25°C	I_F = 16 mA		1	
Input Reverse Breakdown Voltage	BV_R		5			V	I_R = 10 µA				
Input Capacitance	C_{IN}			60		pF	f = 1 MHz, V_F = 0 V				

Switching Specifications (AC)

Over Recommended Temperature (T_A = 0°C to +70°C), V_{CC} = 3.3 V, I_F = 16 mA unless otherwise specified.
All typicals at V_{CC} = 3.3 V, T_A = 25°C.

Parameter	Sym.	Device	Min.	Typ.*	Max.	Units	Test Conditions		Fig.	Note
Propagation Delay Time to Logic Low at Output	t_{PHL}			0.35	1	µs		R_L = 1.9 kΩ	5	8, 9
Propagation Delay Time to Logic High at Output	t_{PLH}			0.65	1	µs		R_L = 1.9 kΩ	5	8, 9
Common Mode Transient Immunity at Logic High Level Output	$\|CM_H\|$			1		kV/µs	R_L = 4.1 kΩ R_L = 1.9 kΩ	I_F = 0 mA, T_A = 25°C, V_{CM} = 10 V_{p-p} C_L = 15 pF	6	7, 8, 9
Common Mode Transient Immunity at Logic Low Level Output	$\|CM_L\|$			1		kV/µs	R_L = 4.1 kΩ R_L = 1.9 kΩ	I_F = 16 mA, T_A = 25°C, V_{CM} = 10 V_{p-p} C_L = 15 pF	6	7, 8, 9

*All typicals at T_A = 25°C

Package Characteristics

Over Recommended Temperature (T_A = 0°C to 70°C) unless otherwise specified.

Parameter	Sym.	Device	Min.	Typ.*	Max.	Units	Test Conditions	Fig.	Note
Input-Output Momentary Withstand Voltage**	V_{ISO}	8-Pin DIP SO-8	3750			V rms	RH < 50%, t = 1 min., T_A = 25°C		6, 14
	I_{I-O}	8-Pin DIP			1	μA	45% RH, t = 5 s, V_{I-O} = 3 kVdc, T_A = 25°C		6, 16
Input-Output Resistance	R_{I-O}	8-Pin DIP SO-8		10^{12}		Ω	V_{I-O} = 500 Vdc		6
Input-Output Capacitance	C_{I-O}	8-Pin DIP SO-8		0.6		pF	f = 1 MHz		6

*All typicals at T_A = 25°C.

**The Input-Output Momentary Withstand Voltage is a dielectric voltage rating that should not be interpreted as an input-output continuous voltage rating. For the continuous voltage rating refer to the IEC/EN/DIN EN 60747-5-2 Insulation Related Characteristics Table (if applicable), your equipment level safety specification or Agilent Application Note 1074 entitled "Optocoupler Input-Output Endurance Voltage," publication number 5963-2203E.

Notes:

1. Derate linearly above 70°C free-air temperature at a rate of 0.8 mA/°C (8-Pin DIP).
   Derate linearly above 85°C free-air temperature at a rate of 0.5 mA/°C (SO-8).
2. Derate linearly above 70°C free-air temperature at a rate of 1.6 mA/°C (8-Pin DIP).
   Derate linearly above 85°C free-air temperature at a rate of 1.0 mA/°C (SO-8).
3. Derate linearly above 70°C free-air temperature at a rate of 0.9 mW/°C (8-Pin DIP).
   Derate linearly above 85°C free-air temperature at a rate of 1.1 mW/°C (SO-8).
4. Derate linearly above 70°C free-air temperature at a rate of 2.0 mW/°C (8-Pin DIP).
   Derate linearly above 85°C free-air temperature at a rate of 2.3 mW/°C (SO-8).
5. CURRENT TRANSFER RATIO in percent is defined as the ratio of output collector current, I_O, to the forward LED input current, I_F, times 100.
6. Device considered a two-terminal device: Pins 1, 2, 3, and 4 shorted together and Pins 5, 6, 7, and 8 shorted together.
7. Common mode transient immunity in a Logic High level is the maximum tolerable (positive) dV_{CM}/dt on the leading edge of the common mode pulse signal, V_{CM}, to assure that the output will remain in a Logic High state (i.e., V_O > 2.0 V). Common mode transient immunity in a Logic Low level is the maximum tolerable (negative) dV_{CM}/dt on the trailing edge of the common mode pulse signal, V_{CM}, to assure that the output will remain in a Logic Low state (i.e., V_O < 0.8 V).
8. The 1.9 kΩ load represents 1 TTL unit load of 1.6 mA and the 5.6 mA kΩ pull-up resistor.
9. The 4.1 kΩ load represents 1 LSTTL unit load of 0.36 mA and 6.1 kΩ pull-up resistor.
10. The frequency at which the AC output voltage is 3 dB below its mid-frequency value.
11. The JEDEC registration for the 6N136 specifies a minimum CTR of 15%. Agilent guarantees a minimum CTR of 15%.
12. See Option 020 data sheet for more information.
13. Use of a 0.1 μf bypass capacitor connected between pins 5 and 8 is recommended.
14. In accordance with UL 1577, each optocoupler is proof tested by applying an insulation test voltage ≥ 4500 V rms for 1 second (leakage detection current limit, $I_{I-O} \leq 5$ μA). This test is performed before the 100% Production test shown in the IEC/EN/DIN EN 60747-5-2 Insulation Related Characteristics Table, if applicable.
15. In accordance with UL 1577, each optocoupler is proof tested by applying an insulation test voltage ≥ 6000 V rms for 1 second (leakage detection current limit, $I_{I-O} \leq 5$ μA). This test is performed before the 100% Production test shown in the IEC/EN/DIN EN 60747-5-2 Insulation Related Characteristics Table, if applicable.
16. This rating is equally validated by an equivalent AC proof test.

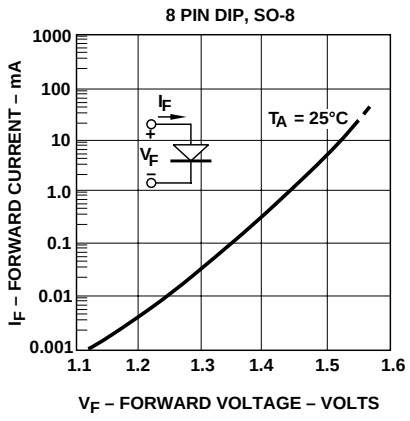


Figure 1. Input current vs. forward voltage.

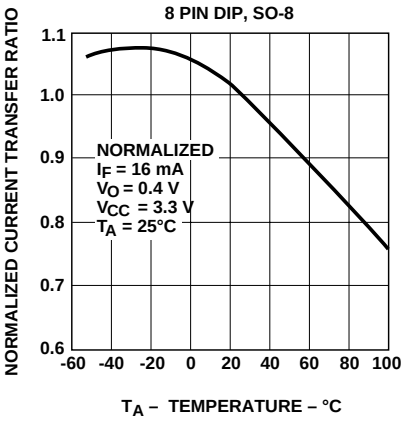


Figure 2. Current transfer ratio vs. temperature.

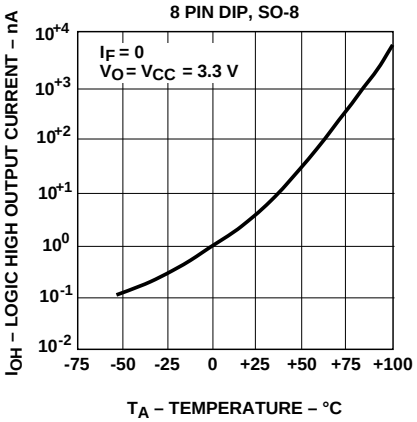


Figure 3. Logic high output current vs. temperature.

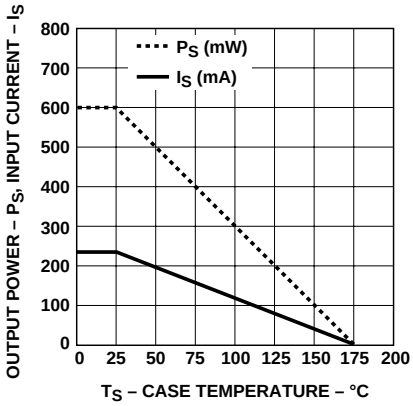


Figure 4. Thermal derating curve, dependence of safety limiting value with case temperature per IEC/EN/DIN EN 60747-5-2.

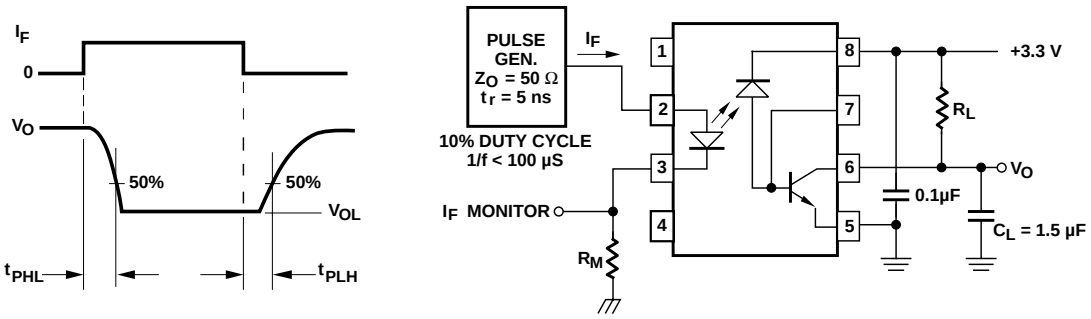


Figure 5. Switching test circuit.

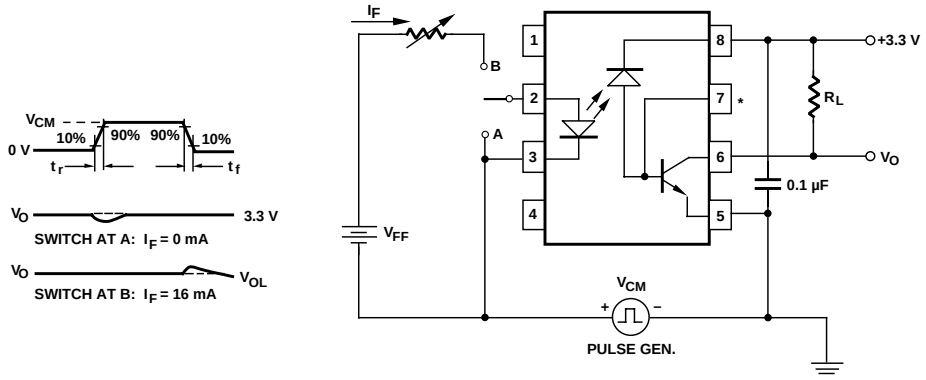


Figure 6. Test circuit for transient immunity and typical waveforms.

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Data subject to change.

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Obsoletes 5989-0300EN

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